#### **Vision**

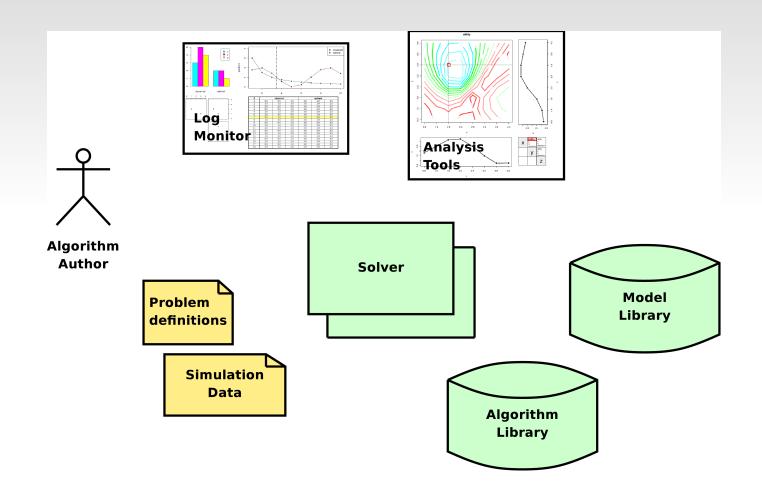
Optimization under uncertainty toolkit:

- test bench for development of new algorithms;
- reference implementation of the algorithms;
- library of limited-rationality-based optimization algorithms for use in real-world applications.

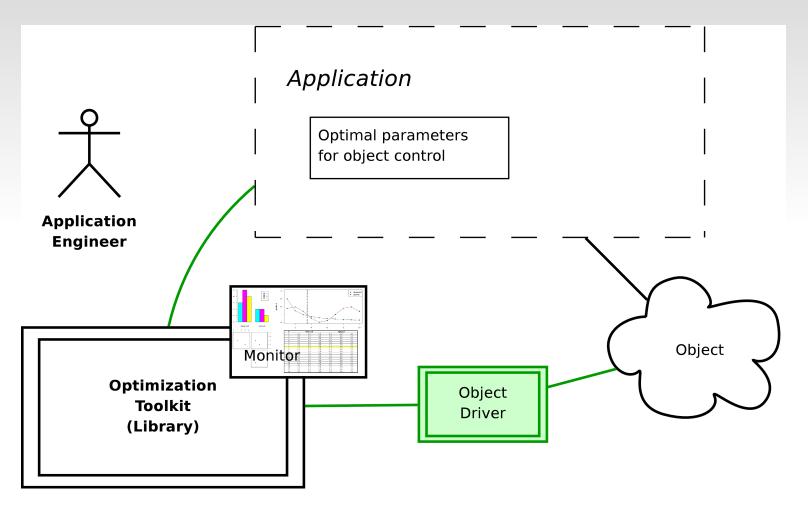
### Roles

- AI Scientist: develops core optimization algorithms for the toolkit;
- Researcher: a colleague of the AI scientist, uses the toolkit as a part of an experiment;
- Application Engineer: employs the algorithms as black boxes, components in an industrial environment.

### **Author's Viewpoint**



### **User's Viewpoint**

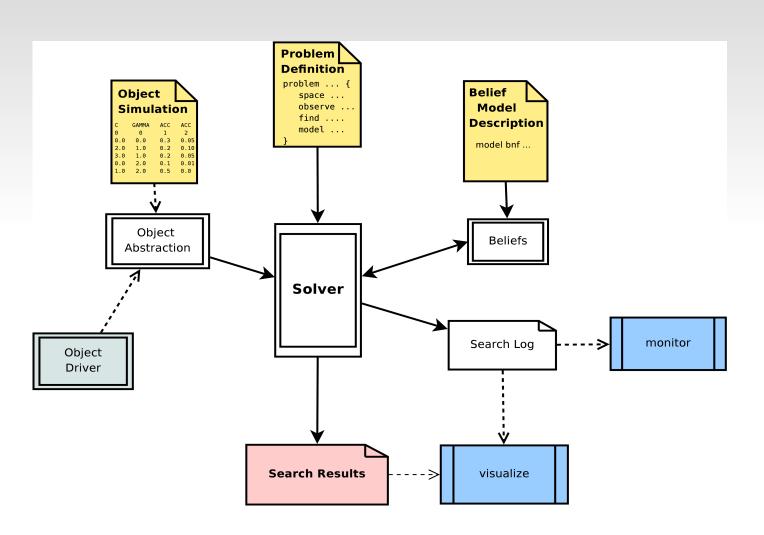


### **Tool Approach**

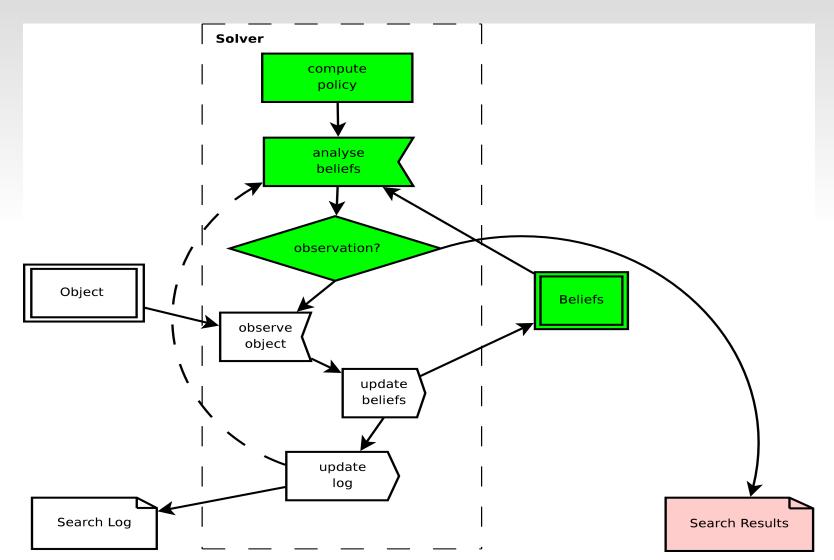
#### Set of self-contained tools:

- easy to implement;
- supports exploratory development of search solutions;
- provides flexible tools for experiments and data analysis;
- allows easy packaging of the algorithms for industrial use.

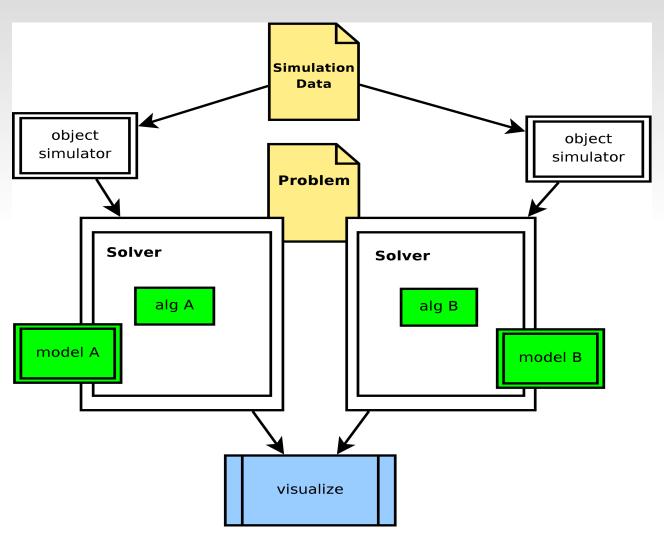
### **Solver — Environment**



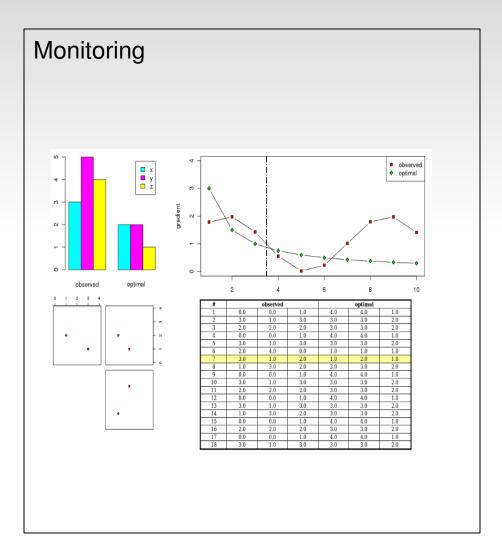
# Solver — Algorithm

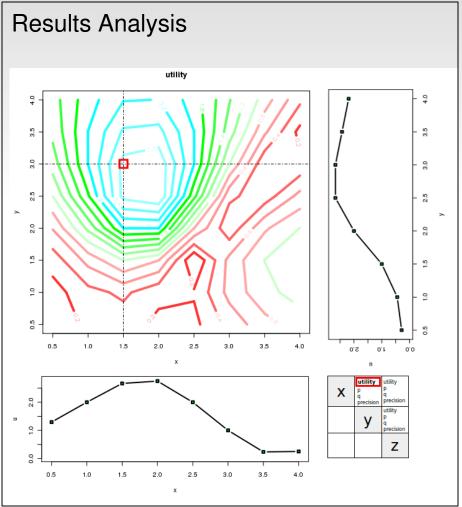


## **Pairwise Comparison**



### **GUI Tools**





### **Problem — SVM RBF**

```
problem svm {
 space (C, gamma) {
  C = [-8, -6 ... 8] / 0.0;
   gamma = [-12, -9 ... 12] / 0.0;
 observe acc {
   1 \Rightarrow acc = 0.5 / 0.10;
find max util[C,gamma] = acc;
model grid(C, gamma) {
   acc = (0.0, 100.0) / (2.0, 2.0);
```

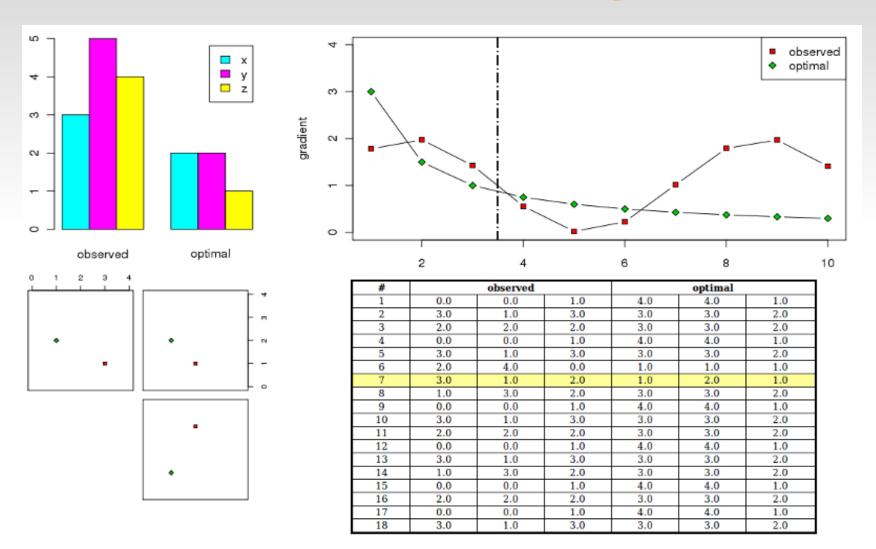
- Find best C,  $\gamma$  for SVM RBF
- Maximize classification accuracy
- Use uniform 2-dimensional grid dependency model

### Problem — Wafer Setup

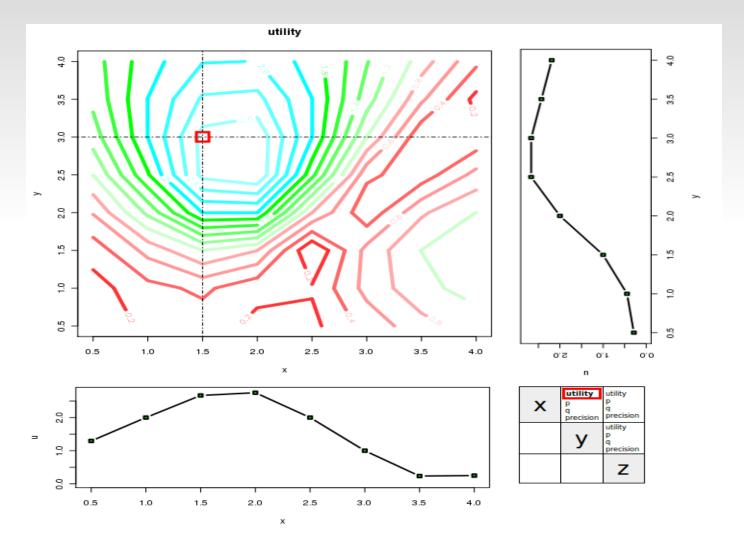
```
problem wafer {
 space (site, focus, color, angle) {
   site = [1, 2 ... 5] / 60;
   focus = [1, 2 .. 31] / 60;
   color = [1, 2 ... 5] / 60;
   angle = [0, 180] / 300;
 observe (x, y, px, py) {
   1 \Rightarrow (x, y, px, py) = (1.0, 1.0, 100.0, 100.0) / 30;
 find max merit[focus, color] =
       1/2-1/12*(tanh((xprec-a prec)/c prec)
              +tanh((yprec-a prec)/c prec)
              +tanh((xtis-a_tis)/c_tis)
              +tanh((ytis-a tis)/c tis)
              +tanh((xtsv-a tsv)/c tsv)
              +tanh((ytsv-a tsv)/c tsv)) {
      xprec = mean(px);
      yprec = mean(py);
      xtis = mean(x[angle=1]-x[angle=0]);
      ytis = mean(y[angle=1]-y[angle=0]);
      xtsv = sd(x[angle=1]-x[angle=0]);
      ytsv = sd(y[angle=1]-y[angle=0]);
      a prec = 1.0;
      c prec = 1.0;
      a tis = 1.0;
      c tis = 1.0:
      a tsv = 1.0;
      c tsv = 1.0;
model bif "wafer.bif";
```

- Find best focus and color for wafer measurement
- Observe four features (x, y, px, py) in 4-dimensional space (site, focus, color, angle)
- Maximize utility function of 6 arguments
- Use dependency model in Bayes Interchange Format, stored in external file

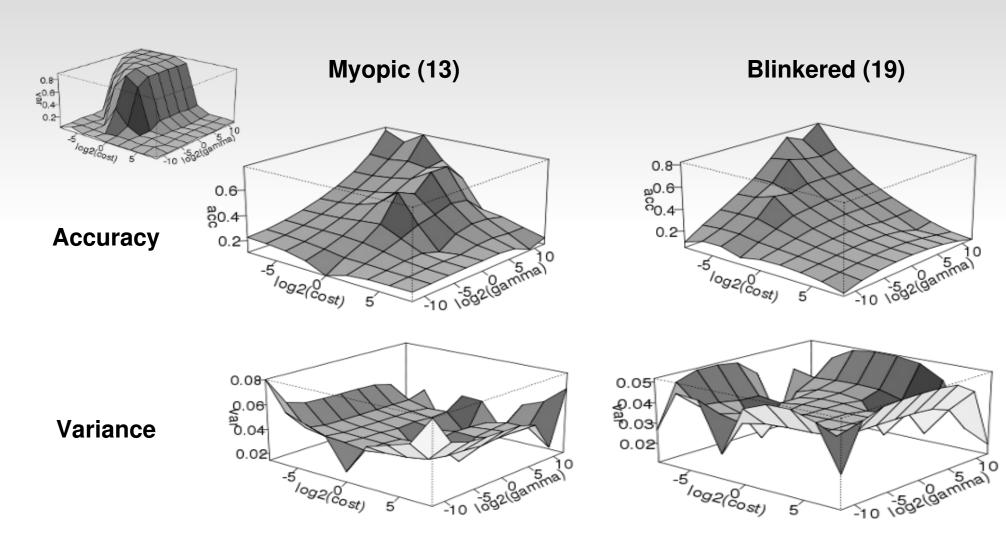
### Monitoring



### **Results Analysis**

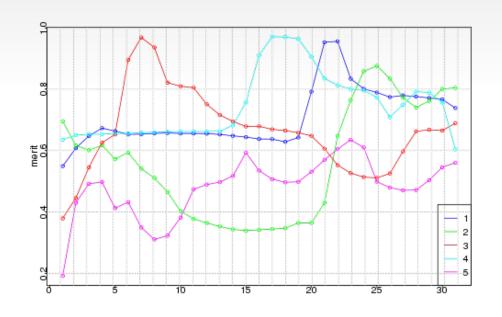


## **SVM** parameter search



## **KLA** metrology

#### **Actual data**



#### ≈10% of measurements

